



## H-621

### Main application

H-621 is a single-component adhesive, based on modified epoxy resin. It is well suitable for strain gages with thin

backing and those that work in elevated humidity environment. Operating temperature range is -40...+250°C.

### Polymerization

Thermal treatment.

### Content

One-component, epoxy-based.

### Key features

Strong adhesion, excellent isolation qualities, low viscosity.

### Operation temperature range

-40°C...+250°C.

### Shelf life

220 days at 2...10°C; 240 days at 2...5°C.

### Bonding technology

- Press or clamp with 0.1...0.3MPa force.
- Heat up to 180°C with the speed not more than 2°C per minute, treat for 3 hours.
- Cool down to room temperature and release the clamp.

### Packing

**6 bottles box:** 15g/bottle.